STARPOWER

SEMICONDUCTOR

IGBT

GD50FSA120L3SM

1200V/50A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

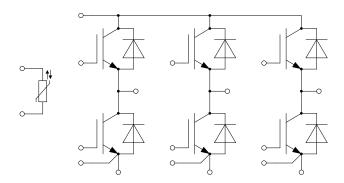
Features

- Low V_{CE(sat)} Trench IGBT technology
- short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated heatsink using DBC technology
- Pre-applied phase change material

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings T_H =25°C unless otherwise noted

IGBT

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	±20	V
$I_{\rm C}$	Collector Current @ T _H =65°C	56	A
I_{CRM}	Repetitive Peak Collector Current tp limited by T _{vjop}	100	A

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_{F}	Diode Continuous Forward Current	50	A
I_{FRM}	Repetitive Peak Forward Current tp limited by T _{vjop}	100	A

Module

Symbol	Description	Value	Unit
T_{vimax}	Maximum Junction Temperature	175	°C
T_{vjop}	Operating Junction Temperature	-40 to +175	°C
T_{STG}	Storage Temperature Range	-40 to +125	°C
$V_{\rm ISO}$	Isolation Voltage RMS,f=50Hz,t=1min	2500	V

Note: $T_{vjop} > 150^{\circ} \mathrm{C}$ is allowed for operation at overload conditions.

IGBT Characteristics T_H =25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{\text{CE(sat)}}$		$I_{\rm C}$ =50A, $V_{\rm GE}$ =15V, $T_{\rm vj}$ =25°C		1.50	1.95	
	Collector to Emitter Saturation Voltage	$I_{C}=50A, V_{GE}=15V, T_{vj}=125^{\circ}C$		1.70		V
		$I_{C}=50A, V_{GE}=15V, T_{vj}=150^{\circ}C$		1.80		
$V_{\text{GE(th)}}$	Gate-Emitter Threshold Voltage	$I_{C}=1.00$ mA, $V_{CE}=V_{GE}$, $T_{vj}=25$ °C	5.3	6.2	7.0	V
I_{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V, T_{vi} = 25^{\circ}C$			50	uA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V,$ $T_{v}=25^{\circ}C$			100	nA
R _{Gint}	Internal Gate Resistance			0		Ω
C _{ies}	Input Capacitance	V _{CE} =25V,f=1MHz,		4.42		nF
C_{res}	Reverse Transfer Capacitance	$V_{GE}=23V,I=1MHZ,$ $V_{GE}=0V$		0.04		nF
Q_{G}	Gate Charge	V _{GE} =-15+15V		0.32		μС

Diode Characteristics $T_H=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V_{F}	Diode Forward Voltage	$I_F = 50A, V_{GE} = 0V, T_{vj} = 25^{\circ}C$		1.60	2.05	
		$I_F = 50A, V_{GE} = 0V, T_{vi} = 125^{\circ}C$		1.65		V
		$I_F = 50A, V_{GE} = 0V, T_{vi} = 150^{\circ}C$		1.65		

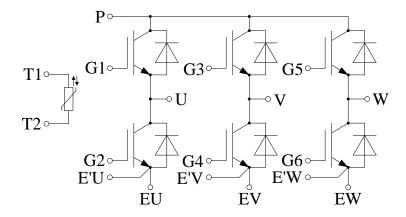
NTC Characteristics T_H =25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
R ₂₅	Rated Resistance			5.0		kΩ
$\Delta R/R$	Deviation of R ₁₀₀	$T_{\rm C}$ =100 °C, R_{100} =493.3 Ω	-5		5	%
P ₂₅	Power Dissipation				20.0	mW
B _{25/50}	B-value	$R_2=R_{25}exp[B_{25/50}(1/T_2-1/(298.15K))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}exp[B_{25/80}(1/T_2-1/(298.15K))]$		3411		K
B _{25/100}	B-value	$R_2=R_{25}exp[B_{25/100}(1/T_2-1/(298.15K))]$		3433		K

Module Characteristics T_H =25°C unless otherwise noted

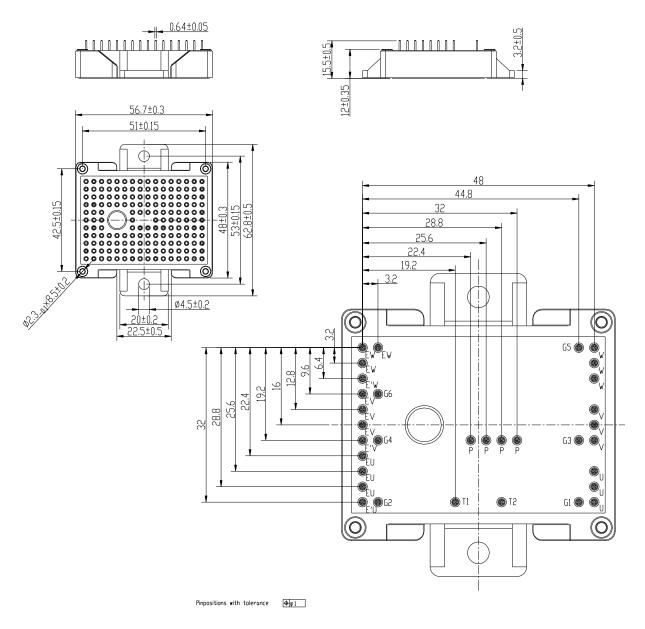
Symbol	Parameter	Min.	Тур.	Max.	Unit
L_{CE}	Stray Inductance		30		nН
R _{CC'+EE'} R _{AA'+CC'}	Module Lead Resistance, Terminal to Chip		5.00 6.00		mΩ
R_{thJH}	Junction-to-Heatsink(per IGBT, λ_{grease} =3.3 W/(m*K)) Junction-to-Heatsink(per Diode, λ_{grease} =3.3 W/(m*K))		0.955 1.220		K/W
F	Mounting Force Per Clamp	40		80	N
G	Weight of Module		39		g

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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